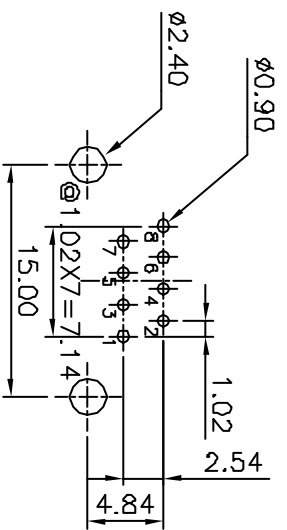
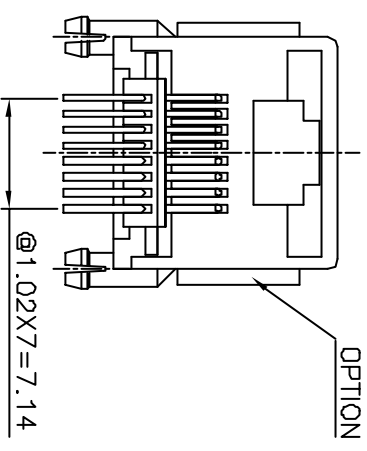
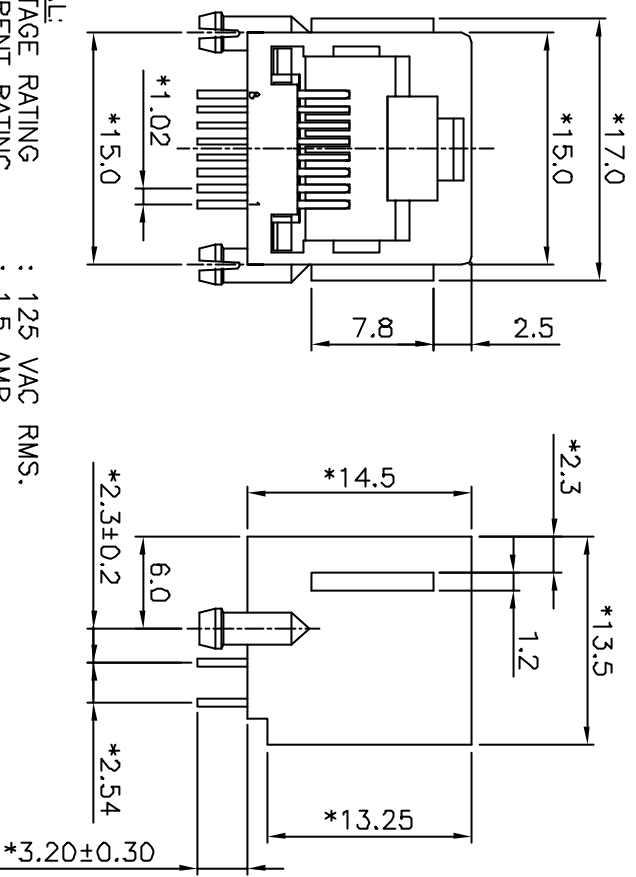


REVISION RECORD				
REV	ECO	DESCRIPTION	DFT	CHKD
△		ADD P/N	Yuan	
△		ADD P/N	Yuan	
△		ADD P/N	Yuan	
△		ADD P/N	Yuan	



PC Board layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : PBT+30%G.F UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE $\phi 0.46$ mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
 2. OPERATION: 0°C TO 70°C.
 3. WAVE SOLDERING TEMPERATURE: 230°C~250°C (5~10 SECONDS)
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

CUL FILE NO. E163191

ROHS PART NUMBER: E55BX-20LXXX-L

NO. OF CONTACT:

- 2- 2C 4- 4C
- 6- 6C 8- 8C

- 1- 3u" 2- 6u"
- 3- 15u" 4- 30u"
- 5- 50u" 6- Pd 20u"

- 83-A06-2320-L W/O OPTION,COLOUR:GY (6C)
- 52-A06-1490-L W/O OPTION,COLOUR:BK
- 51-A06-1490-L W/O OPTION,COLOUR:BK
- DZ-A06-0060 W/O PANEL STOP W/O LOGO GY△

8 7 6 5 4 3 2 1

DIMENSIONS		TOLERANCES EXCEPT AS NOTED		DETACHED LISTS	
MIN	MAX	MIN	MAX	NO.	DESCRIPTION
$\phi \pm 0.02$		$\phi \pm 0.02$		1- 3u"	2- 6u"
$AD \pm 0.06$		$AD \pm 0.06$		3- 15u"	4- 30u"
$AD \pm 0.075$		$AD \pm 0.075$		5- 50u"	6- Pd 20u"
ANGLES ± 0.5		FINISH :		DRAWING NO. G1553003-LC	
THIRD ANGLE PROJECTION		SCALE : 3:1		/PART NO. SEE NOTE	
		DO NOT SCALE DRAWING		SIZE REV	
				A3 3	
				SHEET OF	

FULL RISE ELECTRONIC CO., LTD

MINI L/P SIDE ENTRY PCB JACK 8P